

# Sapphire X-ray sensors: construction and characterization

# Workshop on sapphire detector construction

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remote meeting

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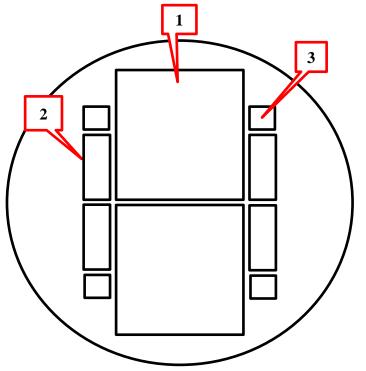
R&D Center «AET» Tomsk State University, Tomsk, Russia

# **Sapphire X-ray sensors construction**

## The wafers were used for sensor producing

- Three wafers from different producers were pixelated:
  - Wafer # 1 Monocrystal Ltd (Russia), 30 mm\*48 mm, and 0.15 mm thick;
  - Wafer # 2 SITUS Technicals GmbH (Wuppertal, Germany), 50 mm diameter, and 0.1 mm thick.
  - Wafer # 3 US university (US), 50 mm diameter, and 0.15 mm thick.

#### Sapphire microstrip senor layout

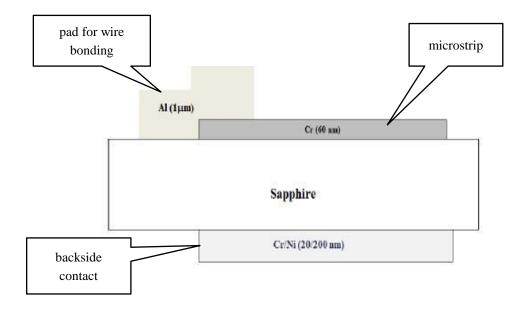


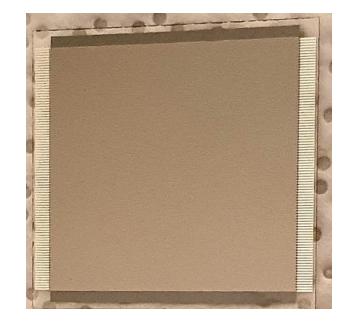
1 - 192 channels microstrip sensor with sizes of 23×22 мм<sup>2</sup>

**2** - 4 channels microstrip sensor with sizes of  $3 \times 11 \text{ MM}^2$  (10 mm strip length)

 $3-2.5\times2.5$  мм<sup>2</sup> pad sensor

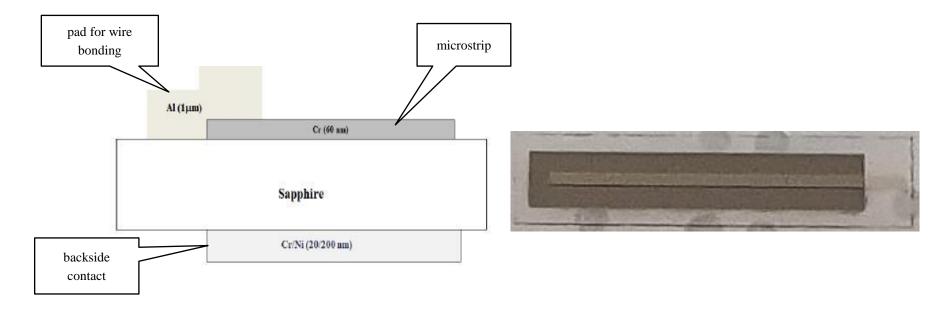
#### **Microstrip sapphire X-ray sensors for 192 channels**





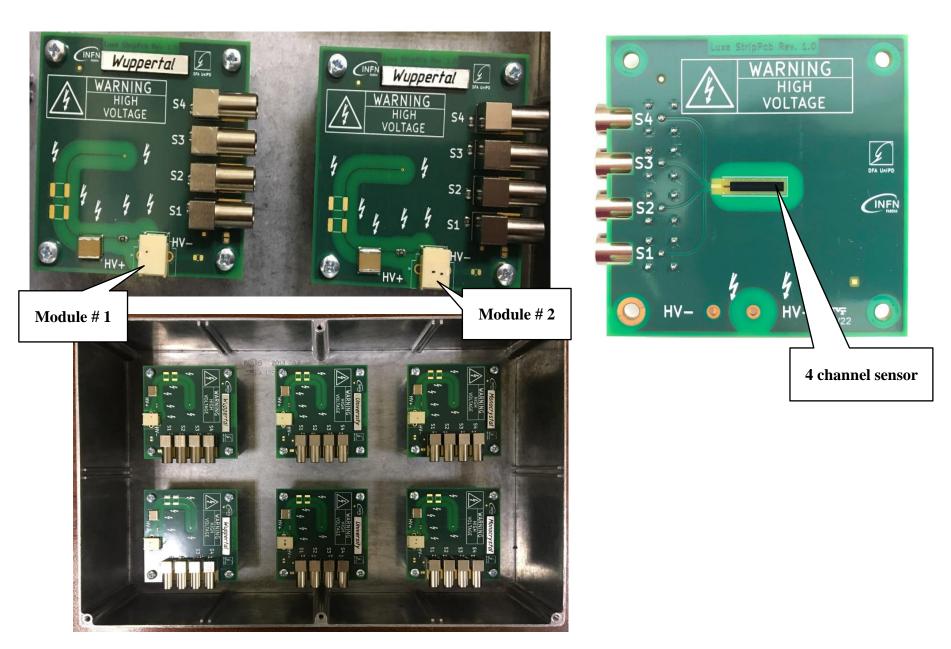
Sapphire thickness, µm	100-150
Metallization	60 nm Cr (microstrip)
	20 nm Cr/200 nm Ni (backside)
Bonding pads	1.0 um Al
Bonding pad size, μm	1200x160
Bonding pad location	Left-right
Number of microstrips	192

## **Microstrip sapphire X-ray sensors for 4 channels**



Sapphire thickness, µm	100-150
Metallization	60 nm Cr (microstrip)
	20 nm Cr/200 nm Ni (backside)
Bonding pads	1.0 um Al
Bonding pad size, μm	1200x160
Bonding pad location	Left-right
Number of microstrips	192

#### Sensor module based on 4 channel sensor



#### 192 channel microstrip sensors



#### Conclusion

4 channel sensor (6 items) and 192 channel microstrip sensors (8 items) microstrip sapphire X-ray sensors were design and produced

4 sensor modules based on 4 channel sensor (6 items) were assembled and tested under DC X-ray beam

The devices were delivered to Padova in May-June, 2022

# Thank you for your time !